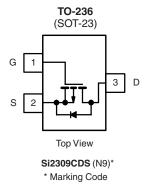


Si2309CDS

Vishay Siliconix

P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A) ^d	Q _g (Typ.)			
- 60	0.345 at V _{GS} = - 10 V	- 1.6	2.7 nC			
- 60	0.450 at V _{GS} = - 4.5 V	- 1.4	2.7 110			



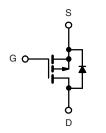
FEATURES

- Halogen-free Option Available
- TrenchFET[®] Power MOSFET

APPLICATIONS

· Load Switch





P-Channel MOSFET

Ordering Information: Si2309CDS-T1-E3 (Lead (Pb)-free) Si2309CDS-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter		Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	- 60	V	
Gate-Source Voltage		V _{GS}		± 20
	T _C = 25 °C		- 1.6	
	T _C = 70 °C		- 1.3	
Continuous Drain Current (T _J = 150 °C) ^{a, b}	T _A = 25 °C	I _D	- 1.2 ^{a, b}	
	T _A = 70 °C		- 1.0 ^{a, b}	
Pulsed Drain Current (10 µs Pulse Width)	I _{DM}	- 8	A	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	- 5	
	T _C = 25 °C	1	- 1.4	
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	- 0.9 ^{a, b}	
	T _C = 25 °C		1.7	
	T _C = 70 °C	Р	1.1	w
Maximum Power Dissipation	T _A = 25 °C	P _D	1.0 ^{a, b}	
	T _A = 70 °C		0.67 ^{a, b}	
Operating Junction and Storage Temperature Ran	T _J , T _{stg}	- 55 to 150	•••	
Soldering Recommendations (Peak Temperature)		260		

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient ^{a, c}	$t \le 5 s$	R _{thJA}	92	120	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	58	73			
Notes:			•	•			

a. Surface Mounted on 1" x 1" FR4 board.

b. t = 5 s.

c. Maximum under Steady State conditions is 166 $^{\circ}\text{C/W}.$

d. When T_C = 25 °C.



Vishay Siliconix

SPECIFICATIONS $T_J = 25 \degree C$				1	1	1
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static				1	1	1
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = - 250 μA	- 60			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = - 250 μA		- 65		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			4.5		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = -250 \ \mu A$	- 1		- 3	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			- 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$			- 1	μA
Zelo dale voltage Dialit ourient	'DSS	V_{DS} = - 60 V, V_{GS} = 0 V, T_{J} = 55 $^{\circ}C$			- 10	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le 5$ V, V_{GS} = - 10 V	- 6			A
Drain-Source On-State Resistance ^a	D	V _{GS} = - 10 V, I _D = - 1.25 A	0.285		0.345	
	R _{DS(on)}	V _{GS} = - 4.5 V, I _D = - 1.0 A		0.360	0.450	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 1.0 A		2.8		S
Dynamic ^b		· · · · · · · · · · · · · · · · · · ·		•		
Input Capacitance	C _{iss}			210		pF
Output Capacitance	C _{oss}	V _{DS} = - 30 V, V _{GS} = 0 V, f = 1 MHz		28		
Reverse Transfer Capacitance	C _{rss}			20		
Total Gate Charge	Qg			2.7	4.1	nC
Gate-Source Charge	Q _{gs}	V_{DS} = - 30 V, V_{GS} = - 4.5 V, I_{D} = - 1.25 A		0.8		
Gate-Drain Charge	Q _{gd}			1.2		
Gate Resistance	R _g	f = 1 MHz		7		Ω
Turn-On Delay Time	t _{d(on)}			40	60	
Rise Time	t _r	V_{DD} = - 30 V, R_L = 30 Ω		35	55	-
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 1 A, V_{GEN} = - 4.5 V, R_g = 1 Ω		15	25	
Fall Time	t _f			10	20	
Turn-On Delay Time	t _{d(on)}			5	10	ns
Rise Time	t _r	V_{DD} = - 30 V, R_L = 30 Ω		10	20	-
Turn-Off Delay Time	t _{d(off)}	$I_D \cong$ - 1 A, V_{GEN} = - 10 V, R_g = 1 Ω		15	25	
Fall Time	t _f			10	20	
Drain-Source Body Diode Characteris	tics	· · · · · · · · · · · · · · · · · · ·		•		
Continuous Source-Drain Diode Current	۱ _S	$T_{\rm C} = 25 \ ^{\circ}{\rm C}$			- 1.4	А
Pulse Diode Forward Current	I _{SM}				- 8	
Body Diode Voltage	V _{SD}	I _S = - 0.75 A, V _{GS} = 0 V		- 0.8	- 1.2	V
Body Diode Reverse Recovery Time	t _{rr}			30	60	ns
Body Diode Reverse Recovery Charge	Q _{rr}	L = 1.25 A d/dt = 100 A/mo T = 05 °C		33	60	nC
Reverse Recovery Fall Time	t _a	I _F = - 1.25 A, dl/dt = 100 A/μs, T _J = 25 °C		18		
Reverse Recovery Rise Time	t _b			12		ns

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

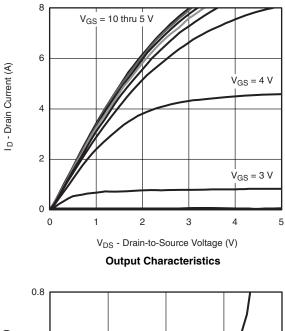


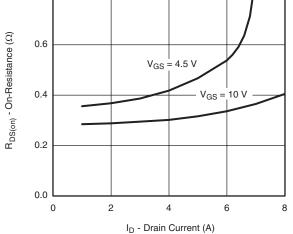


Si2309CDS

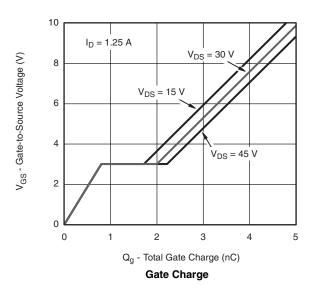
Vishay Siliconix

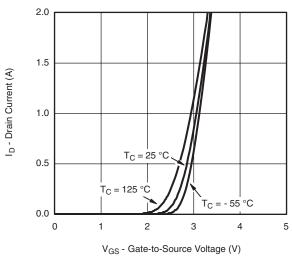




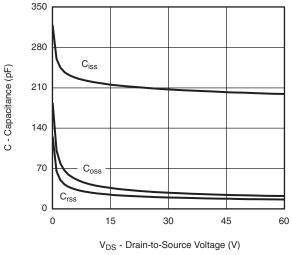


On-Resistance vs. Drain Current and Gate Voltage

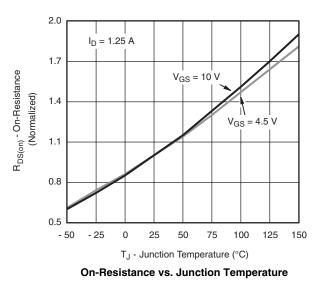




Transfer Characteristics



Capacitance



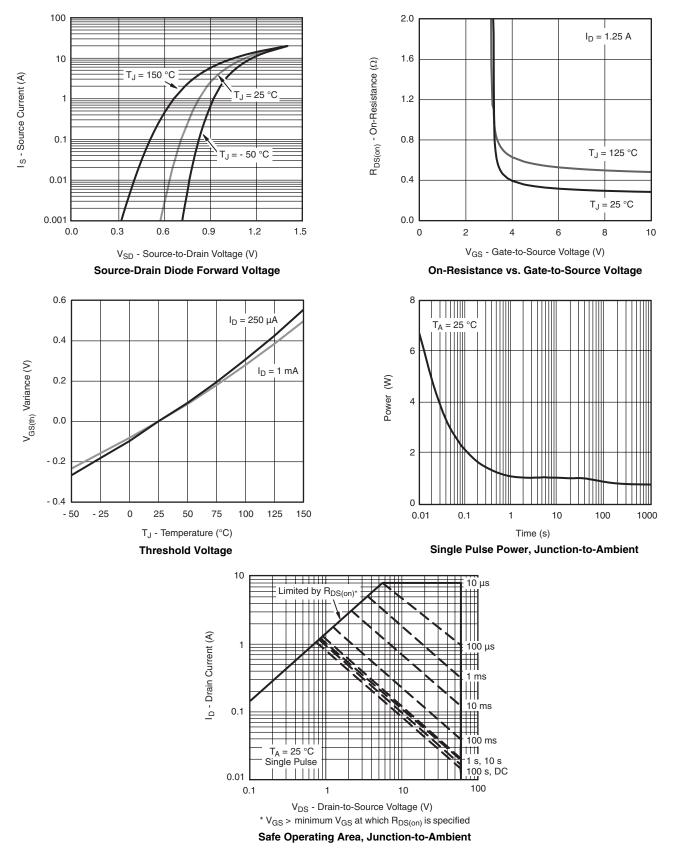
Document Number: 68980 S-82584-Rev. A, 27-Oct-08

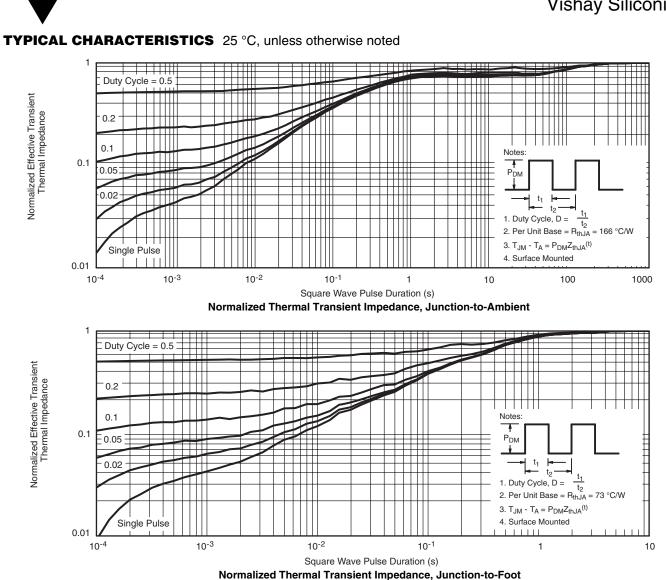
Si2309CDS

Vishay Siliconix



TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?68980.



Si2309CDS Vishay Siliconix



Package Information

Vishay Siliconix

SOT-23 (TO-236): 3-LEAD







Dim	MILLIN	METERS	INCHES		
	Min	Max	Min	Мах	
Α	0.89	1.12	0.035	0.044	
A ₁	0.01	0.10	0.0004	0.004	
A ₂	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E ₁	1.20	1.40	0.047	0.055	
е	0.95 BSC		0.0374 Ref		
e ₁	1.90 BSC		0.0748 Ref		
L	0.40	0.60	0.016	0.024	
L ₁	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	



Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR SOT-23



Recommended Minimum Pads Dimensions in Inches/(mm)

Return to Index



Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.